

**H11M1, H11M2**

# Optoisolator

## GaAlAs Infrared Emitting Diode and Light Activated SCR

The H11M1 and H11M2 contain a gallium-aluminum-arsenide, infrared emitting diode coupled to a unique high voltage silicon controlled rectifier within a dual in-line package. These devices are optimized for high performance and long life. They are especially suited for the control of industrial AC power lines from low voltage logic integrated circuitry. These devices are also available in surface-mount packaging.

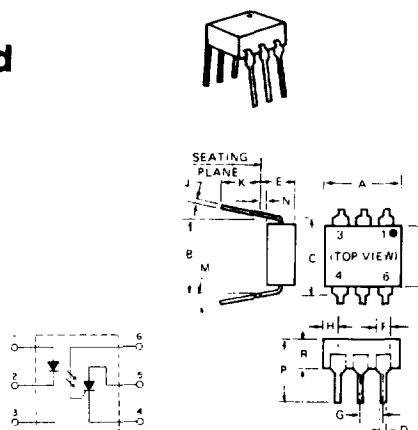
**FEATURES**

- High blocking voltage, 800 V minimum
- High isolation voltage, 3750 V<sub>rms</sub> minimum (steady state)
- High efficiency, low degradation, liquid epitaxial IRED
- Logic compatible drive current, 7 mA at 1.5 V maximum
- Unique, high performance glass dielectric construction

absolute maximum ratings: (25°C)

INFRARED EMITTING DIODE		
Power Dissipation	*100	milliWatts
Forward Current (Continuous)	60	milliAmpere
Forward Current (Peak) (Pulse width 10 $\mu$ sec)		
Duty Cycle 1%	1	Ampere
Reverse Voltage	6	volts

\*Derate 1.33mW/°C above 25°C ambient.



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	8.38	8.89	.330	.350	
B	7.62	REF.	.300	REF.	1
C		8.64		.340	2
D	.406	.508	.016	.020	
E		5.08		.200	3
F	1.01	1.78	.040	.070	
G	2.28	2.40	.090	.110	
H		2.16		.065	4
J	2.03	.305	.008	.012	
K	2.54		.100		
M	3.81	15°	.015	.15°	
N					
P	2.92	9.53	.115	.175	
R	2.92	3.43	.115	.175	
S	6.10	8.88	.240	.270	

## NOTES

1. INSTALLED POSITION LEAD CENTERS.
2. OVERALL INSTALLED DIMENSION.
3. THESE MEASUREMENTS ARE MADE FROM THE SEATING PLANE.
4. FOUR PLACES.

PHOTO-SCR		
Peak Forward Voltage	800	Volts
RMS Forward Current	300	milliAmperes
Peak On-State Current (1 cycle surge, 10 msec)	3	Amperes
Peak Reverse Gate Voltage	5	Volts
Power Dissipation (25°C Ambient)	**400	milliWatts

\*\*Derate 5.3 mW/°C above 25°C ambient.

TOTAL DEVICE		
Storage Temperature	-55°C to +150°C	
Operating Temperature	-55 to +100°C	
Lead Soldering Time (at 260°C)	10 seconds	
Surge Isolation Voltage (Input to Output)	5656 V <sub>(peak)</sub>	4000 V <sub>(rms)</sub>
Steady-State Isolation Voltage (Input to Output),		
	5300 V <sub>(peak)</sub>	3750 V <sub>(rms)</sub>

Covered under U.L. component recognition program. reference file E51868

**H11M1, H11M2****individual electrical characteristics (25°C) (unless otherwise indicated)**

<b>EMITTER</b>	<b>SYMBOL</b>	<b>TYP.</b>	<b>MAX.</b>	<b>UNITS</b>
Forward Voltage ( $I_F = 10 \text{ mA}$ )	$V_F$	1.3	1.65	V
Reverse Current ( $V_R = 5V$ )	$I_R$	—	10	$\mu\text{A}$
Capacitance ( $V_{AK} = 0V$ , $F = 1 \text{ MHz}$ )	$C_J$	50		pF

<b>DETECTOR</b>	<b>SYMBOL</b>	<b>MIN.</b>	<b>TYP.</b>	<b>MAX.</b>	<b>UNITS</b>
Off-State Voltage ( $R_{GK} = 10\text{K}\Omega$ , $I_D = 100\mu\text{A}$ , $T_A = 100^\circ\text{C}$ )	$V_{DM}$	800			V
Reverse Voltage ( $R_{GK} = 10\text{K}\Omega$ , $I_R = 100\mu\text{A}$ , $T_A = 100^\circ\text{C}$ )	$V_{RM}$	800			V
On-State Voltage ( $I_{IM} = 300\text{mA}$ )	$V_{TM}$	—		1.5	V
Off-State Current ( $R_{GK} = 10\text{K}\Omega$ , $V_{DM} = 800\text{V}$ , $T_A = 100^\circ\text{C}$ ( $T_A = 25^\circ\text{C}$ )	$I_{DM}$	—		100 400	$\mu\text{A}$ $\text{nA}$
Reverse Current ( $R_{GK} = 10\text{K}\Omega$ , $V_{RM} = 800\text{V}$ , $T_A = 100^\circ\text{C}$ ( $T_A = 25^\circ\text{C}$ )	$I_{RM}$	—		100 400	$\mu\text{A}$ $\text{nA}$
Critical Rate-of-Rise of Off-State Voltage ( $V_{AK} = 800\text{V}$ , $R_{GK} = 10\text{K}\Omega$ )	$dv/dt$		25		V/ $\mu\text{sec}$
Holding Current ( $R_{GK} = 10\text{K}\Omega$ )	$I_H$			2	mA

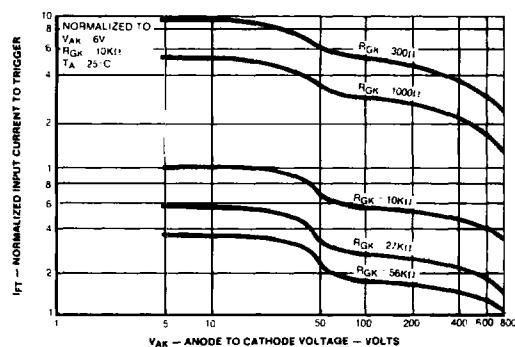
**coupled electrical characteristics (25°C)**

<b>COUPLED</b>	<b>SYMBOL</b>	<b>MIN.</b>	<b>TYP.</b>	<b>MAX.</b>	<b>UNITS</b>
Input Current to Trigger ( $V_{AK} = 6V$ , $R_{GK} = 10\text{K}\Omega$ )	$I_{FI}$			10 20	mA mA
Input Current to Trigger ( $V_{AK} = 6V$ , $R_{GK} = 27\text{K}\Omega$ )	$I_{FI}$			7 15	mA mA
Isolation Resistance (Input to Output) ( $V_{IO} = 500\text{V}$ )	$r_{io}$	100			G $\Omega$
Isolation Capacitance (Input to Output) ( $V_{IO} = 0V$ , $F = 1 \text{ MHz}$ )	$C_{io}$			2	pF
Isolation dv/dt Immunity (Input to Output) See Figure 10		500			V/ $\mu\text{sec}$

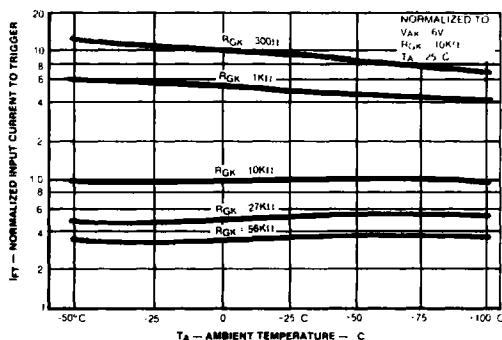
Tests of input to output isolation voltage, isolation resistance, and isolation capacitance are performed with the input terminals (pins 1, 2 & 3) shorted together and the output terminals (pins 4, 5 & 6) shorted together.

## Optoisolator Specifications

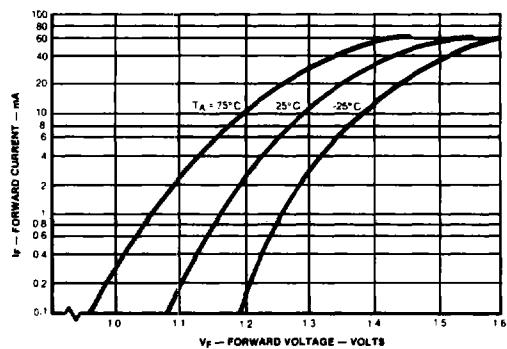
### H11M1, H11M2



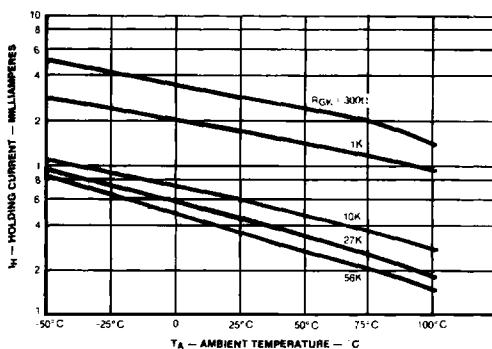
1. INPUT CURRENT TO TRIGGER  
VS. ANODE TO CATHODE VOLTAGE



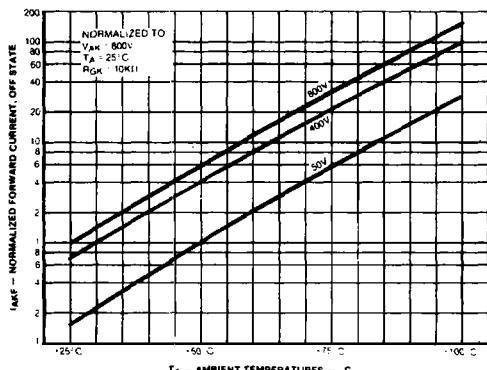
2. INPUT CURRENT TO TRIGGER  
VS. TEMPERATURE



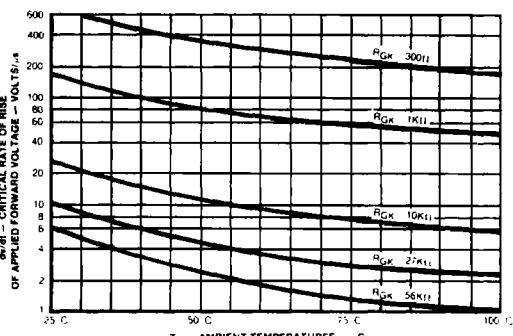
3. INPUT VOLTAGE VS. INPUT CURRENT



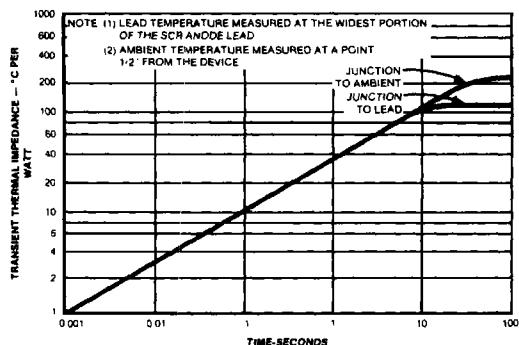
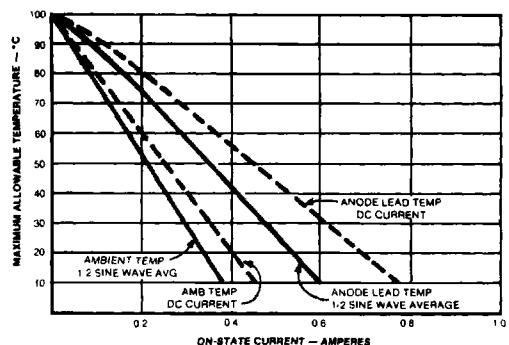
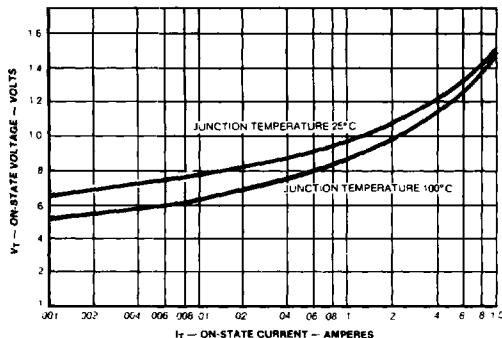
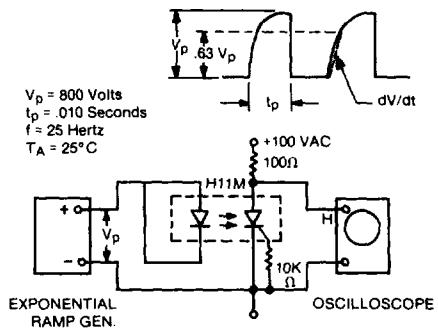
4. HOLDING CURRENT VS. TEMPERATURE



5. OFF-STATE LEAKAGE VS. TEMPERATURE



6.  $dv/dt$  VS. TEMPERATURE

**H11M1, H11M2****7. MAXIMUM TRANSIENT THERMAL IMPEDANCE****8. ON-STATE CURRENT VS. MAXIMUM ALLOWABLE TEMPERATURE****9. ON-STATE CHARACTERISTICS****10. ISOLATION dv/dt IMMUNITY TEST CIRCUIT**